

**In the Claims:**

*Please amend the claims as follows:*

1. (canceled)
2. (canceled)
3. (canceled)
4. (canceled)
5. (canceled)
6. (canceled)

7. (currently amended) An apparatus for shielding a component against electrostatic discharge comprising a light emitting diode placed on a printed circuit board and a photoconductor layer for conducting light emitted by the light emitting diode, wherein the photoconductor layer includes an electroconductive material, and that the electroconductive material is connectable to a ground plane in order to conduct electrostatic discharges from the photoconductor layer to the ground plane, further wherein the photoconductor layer is provided with a first aperture that extends through said photoconductor layer, the light emitting diode at least partly placed in the first aperture, inside the photoconductor layer, and the photoconductor layer also provided with ~~an~~ the electroconductive material at least around the edges of the first aperture,

and further comprising a key having a projection extending through a second aperture provided on said photoconductor layer, said projection configured to press on said circuit board.

8. (canceled)

9. (canceled)

10. (currently amended) The apparatus according to claim 7, wherein the photoconductor layer has a surface and wherein the electroconductive material of the photoconductor layer is integrated as a layer of the electroconductive material for shielding components against electrostatic pulses and for conducting the light emitted by the light emitting diode in the photoconductor layer.

11. (previously presented) The apparatus according to claim 7, wherein the light emitting diode is placed on a printed circuit board, the photoconductor layer is placed on the component side of the circuit board, and the electroconductive material is placed on that side of the photoconductor layer that faces away from the circuit board and the electroconductive material is connectable to the ground plane of the circuit board.

12. (currently amended) The apparatus according to claim 7, wherein the electroconductive material is metal, and it is connected to the ground plane by the electroconductive material.

13. (previously presented) The apparatus according to claim 7, wherein the electroconductive material is realized on the surface of the photoconductor layer by an electroconductive film, or by inducing chemically or electrochemically.

14. (previously presented) The apparatus according to claim 7, further comprising a keypad comprising said key, wherein the light emitting diode on said circuit board is configured to illuminate the keypad, and wherein the photoconductor layer is configured to conduct the light emitted by the light emitting diode to said key of the keypad.

- 15. (canceled)
- 16. (canceled)
- 17. (canceled)
- 18. (canceled)
- 19. (canceled)
- 20. (canceled)
- 21. (canceled)
- 22. (canceled)